

RoHS Compliant

REV	MODIFICATION	DATE	DRAW
A3	Release To ECN20120607	2012.06.26	Michelle
A4	Release To ECN20140101	2013.01.13	Michelle
A5	Release To ECN20150603	2015.06.09	Michelle

Specification

- 1.Current Rating:3A AC/DC
- 2.Voltage Rating:250V AC/DC
- 3.Contact Resistance:20mΩ Max.
- 4.Insulation Resistance:1000MΩ Min. At DC 500V
- 5.Dielectric Withstanding Voltage:AC1000V/Minute
- 6.Operating Temperature:-25°C~+85°C

Material:

- 1.Housing:High Temperature Thermoplastic UL94V-0
- 2.Contact Pin:Copper Alloy SQ. Pin 0.64mm

Finish:

- 1.Housing:See P/N Option
- 2.Contact Pin:See P/N Option

Part No.: AD03614 XX X X 5 A

No. Of Pin
02,04~20

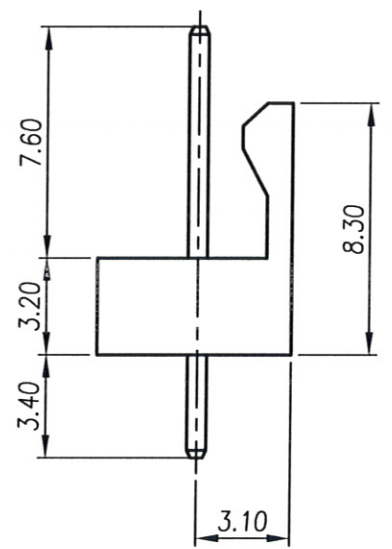
Packing
5:Bag

Housing Material

- 0:PA66 UL94V-0 Red
- T:PA66 UL94V-0 White


Plating

- 1:Bright Tin Plated Over Cu
- 3:Gold Flash Over Nickel
- A:Bright Tin Plated Over Nickel



PIN	DIM.A	DIM.B	PIN	DIM.A	DIM.B	PIN	DIM.A	DIM.B	PIN	DIM.A	DIM.B
02	2.54	5.10	08	17.78	20.44	13	30.48	33.20	18	43.18	45.94
04	7.62	10.24	09	20.32	23.00	14	33.02	35.74	19	45.72	48.50
05	10.16	12.78	10	22.86	25.54	15	35.56	38.30	20	48.26	51.05
06	12.70	15.24	11	25.40	28.10	16	38.10	40.84			
07	15.24	17.88	12	27.94	30.64	17	40.64	43.40			





金上達科技股份有限公司

GOLDENSUNDA TECHNOLOGY CO.,LTD

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROJ.	TITLE: Wire To Board Wafer 2.54mm 180° DIP Short Back Board			
.X± 0.35	.X'± 2'	APR. C.F.Liao 20150609	PART NO. AD03614XXXX5A		DWG NO. AD03614XXXX5A	
.XX± 0.25	.X'± 1'	CHK. Abel 20150609	UNITS: mm		CUSTOMER DRAWING	
.XXX± 0.15	.XX'± 0.5'	DRA. Michelle 20150609	SIZE: A4	SCALE 4:1	SHEET 1 / 1	
			REV A5	V		